## STW65N80K5



# N-channel 800 V, 0.07 Ω typ., 46 A MDmesh™ K5 Power MOSFET in a TO-247 package

Datasheet - production data

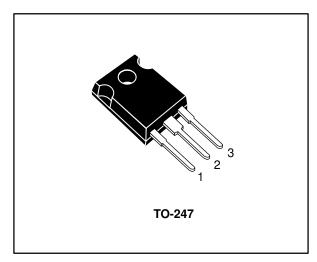
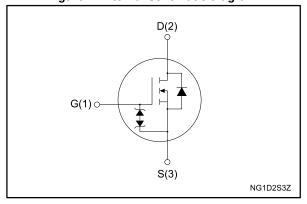


Figure 1: Internal schematic diagram



### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ΙD	Ртот
STW65N80K5	800 V	0.08 Ω	46 A	446 W

- Industry's lowest R<sub>DS(on)</sub> x area
- Industry's best figure of merit (FoM)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### **Description**

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STW65N80K5	65N80K5	TO-247	Tube

Contents STW65N80K5

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STW65N80K5 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	±30	V
I.	Drain current (continuous) at T <sub>case</sub> = 25 °C	46	۸
l <sub>D</sub>	Drain current (continuous) at T <sub>case</sub> = 100 °C	30	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	184	Α
Ртот	Total dissipation at T <sub>case</sub> = 25 °C	446	W
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	4.5	V/ns
dv/dt <sup>(3)</sup>	dv/dt <sup>(3)</sup> MOSFET dv/dt ruggedness		V/IIS
T <sub>stg</sub>	Storage temperature	EE to 1E0	°C
Tj	Operating junction temperature	-55 to 150	C

#### Notes:

Table 3: Thermal data

Symbol Parameter		Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	0.28	0CAM
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	50	°C/W

**Table 4: Avalanche characteristics** 

Symbol	Parameter	Value	Unit	
I <sub>AR</sub> <sup>(1)</sup>	I <sub>AR</sub> <sup>(1)</sup> Avalanche current, repetitive or not repetitive			
E <sub>AS</sub> <sup>(2)</sup>	700	mJ		

#### Notes:

<sup>&</sup>lt;sup>(1)</sup> Pulse width is limited by safe operating area.

 $<sup>^{(2)}</sup>$   $I_{SD} \leq$  46 A, di/dt=100 A/µs;  $V_{DS}$  peak <  $V_{(BR)DSS},$   $V_{DD}$  = 80%  $V_{(BR)DSS}.$ 

 $<sup>^{(3)}</sup> V_{DS} \le 640 V$ 

 $<sup>^{(1)}</sup>$  Pulse width limited by  $T_{jmax}$ .

 $<sup>^{(2)}</sup>$  starting  $T_{j}$  = 25 °C,  $I_{D}$  =  $I_{AR},\,V_{DD}$  = 50 V.

### 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

Table 5: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			٧
	Zaro goto voltago drain	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	
IDSS	I <sub>DSS</sub> Zero gate voltage drain current	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 800 V, T <sub>case</sub> = 125 °C			50	μΑ
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 100 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 23 A		0.07	0.08	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		1	3230	1	
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$	-	310	-	pF
Crss	Reverse transfer capacitance	V <sub>G</sub> S = 0 V	-	3	-	φ.
Coss(eq) <sup>(1)</sup>	Equivalent output capacitance	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$ V	1	734	1	pF
$R_{G}$	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	1.9	-	Ω
Qg	Total gate charge	$V_{DD} = 640 \text{ V}, I_D = 46 \text{ A},$	1	92	1	
Qgs	Gate-source charge	V <sub>GS</sub> = 10 V (see Figure 14: "Test circuit for gate charge	-	18	-	nC
$Q_{gd}$	Gate-drain charge	behavior")	1	65	1	

#### Notes:

Table 7: Switching times

	The state of the s					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 400 \text{ V}, I_D = 23 \text{ A}$	-	34	-	
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 13: "Test circuit for	1	30	1	
t <sub>d(off)</sub>	Turn-off delay time	resistive load switching times"	1	90	1	ns
tf	Fall time	and Figure 18: "Switching time waveform")	-	10	-	

 $<sup>^{(1)}</sup>$  Coss(eq) is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80% VDSs.

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		46	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		184	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 46 A	-		1.5	<b>V</b>
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 46 A, di/dt = 100 A/μs, V <sub>DD</sub> = 60 V (see <i>Figure 15:</i> "Test circuit for inductive load	-	650		ns
Qrr	Reverse recovery charge		-	20		μC
I <sub>RRM</sub>	Reverse recovery current	switching and diode recovery times")	-	60		Α
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 46 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	845		ns
Qrr	Reverse recovery charge	$V_{DD}$ = 60 V, $T_j$ = 150 °C (see Figure 15: "Test circuit for	-	28		μC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	66		Α

#### Notes:

Table 9: Gate-source Zener diode

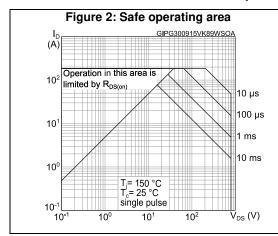
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	±30	-	-	٧

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

<sup>&</sup>lt;sup>(1)</sup> Pulse width is limited by safe operating area.

 $<sup>^{(2)}</sup>$  Pulse test: pulse duration = 300  $\mu$ s, duty cycle 1.5%.

### 2.1 Electrical characteristics (curves)



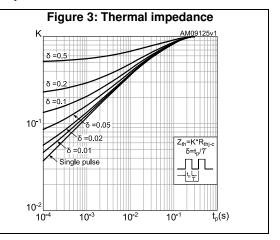
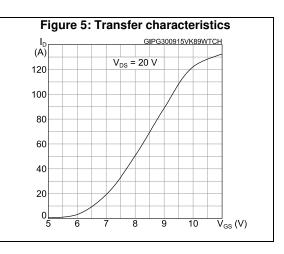
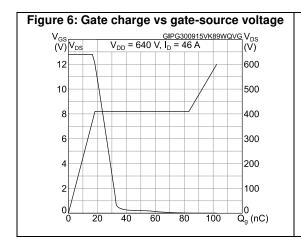
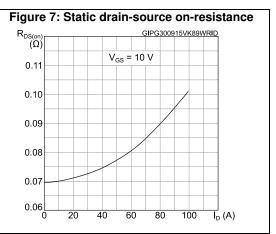


Figure 4: Output characteristics GIPG300915VK89WOCH I<sub>D</sub> (A) 120 V<sub>GS</sub> = 10 V 100 80 V<sub>GS</sub> = 9 V 60  $V_{GS}$  = 8 V 40  $V_{GS} = 7 V$ 20 V<sub>GS</sub> = 6 V 12 16 V<sub>DS</sub> (V)







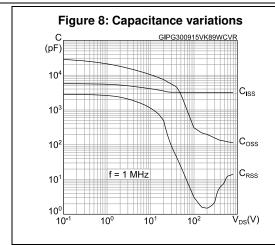
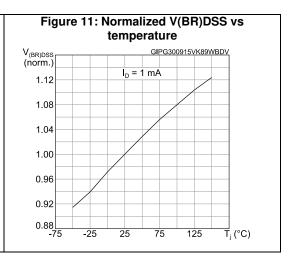


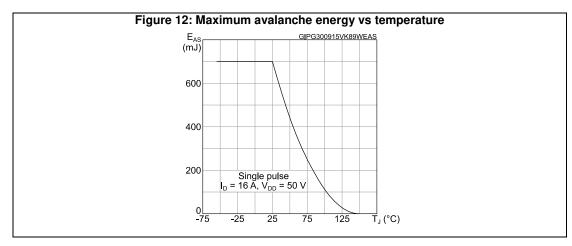
Figure 10: Normalized on-resistance vs temperature

R<sub>DS(on)</sub> GIPG300915VK89WRON

2.6 V<sub>GS</sub> = 10 V

2.2 1.8 1.4 1.0 0.6 0.2 -75 -25 25 75 125 T<sub>j</sub> (°C)





Test circuits STW65N80K5

## 3 Test circuits

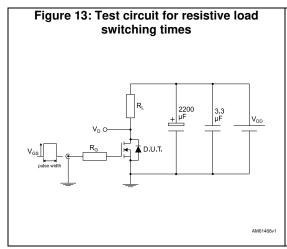
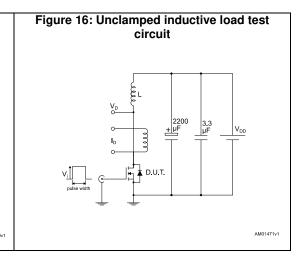


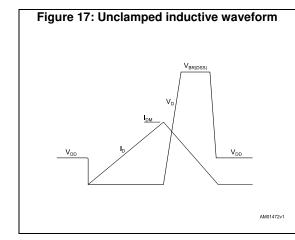
Figure 14: Test circuit for gate charge behavior

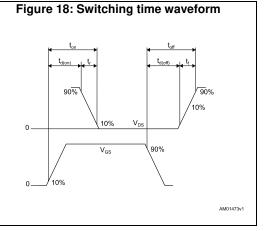
12 V 47 kΩ 100 nF 1 kΩ

Vos 16 CONST 100 nF 100 nF

Figure 15: Test circuit for inductive load switching and diode recovery times







## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

### 4.1 TO-247 package information

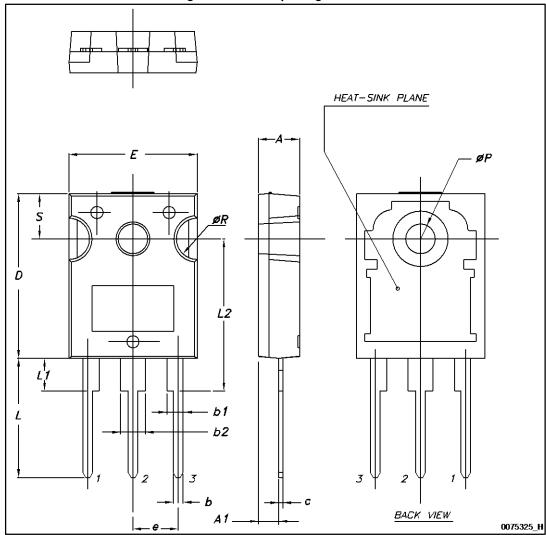


Figure 19: TO-247 package outline

Table 10: TO-247 package mechanical data

Dim	mm.				
Dim.	Min.	Тур.	Max.		
А	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
Е	15.45		15.75		
е	5.30	5.45	5.60		
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
ØP	3.55		3.65		
ØR	4.50		5.50		
S	5.30	5.50	5.70		

STW65N80K5 Revision history

# 5 Revision history

**Table 11: Document revision history** 

Date	Revision	Changes
21-May-2015	1	First release.
02-Oct-2015	2	Text and formatting changes throughout document.  Datasheet status promoted from preliminary to production data.  On cover page: - updated title description and Features table.  Updated sections - Electrical ratings and Electrical characteristics.  Added section - Electrical characteristics (curves).

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